

ID	R _{DS} (ON)(Typ)	VDSS	
31A	86mΩ	600V	

Applications:

- Switch Mode Power Supply(SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- AC-DC Switching Power Supply

Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability
- Fast Recovery Time

Ordering Information

G D S	
RoHS	REACH HF

Part Number	Package	Marking	Packing	Qty.
RSF60R099W T0-247		RSF60R099W	Tube	30 PCS

Absolute Maximun Ratings Tc= 25°C unless otherwise specified

Symbol	Parameter	RSF60R099W	Units	
VDSS	Drain-to-Source Voltage	600	V	
ID	Continuous Drain Current TC=25℃	31		
ID	Continuous Drain Current TC=100℃	19.5	A	
IDM	Pulsed Drain Current (Note*1)	93		
PD	Power Dissipation	205	W	
VGS	Gate- to- Source Voltage	±20	V	
EAS	Single Pulse Avalanche Engergy IAS=3.5A,VDD = 100V, RG = 25 Ω , TC=25 °C	588	mJ	
dv/dt	MOSFET dv/ dt ruggedness VDS = 0400V	50	V/ns	
dv/dt	Reverse diode dv/dt VDS = 0400V, Tj = 25℃, ISD≤ID	15	V/ns	
VESD(G-S)	Gate source ESD(HBM-C=100pF, R=1.5KΩ)	2000	V	
	Maximum Temperature for Soldering	300	°C	
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	260		
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150		

* Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the" Absolute Maximum Ratings" Table may cause permanent damage to the device.



Thermal Resistance

Symbol	Parameter	RSF60R099W	Units	Test Conditions
RØJC	Junction-to-Case	0.59	°C/W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^\circ$ C
RθJA	Junction-to- Ambient	62.5		1 cubic foot chamber,free air.

OFF Characteristics TJ= 25° C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	600			V	VGS=0V,ID=1mA
IDSS	Drain- to- Source Leakage Current			5	μA	VDS=600V,VGS=0 V
	Gate- to- Source Forward Leakage			1		VGS=20V,VDS=0V
IGSS	Gate- to- Source Reverse Leakage			-1	μΑ	VGS=-20V ,VDS=0 V

ON Characteristics TJ=25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On- Resistance(Note*2)		86	99	mΩ	VGS=10V,ID=13.2 A
VGS(TH)	Gate Threshold Voltage	2.5		5	V	VGS=VDS,ID=1.29 mA

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		63			
trise	Rise Time		32			VDS=300V
td(OFF)	Turn- OFF Delay Time		281		nS	ID=16.5A RG=25Ω
tfall	Fall Time		20			



Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		3300			VGS=0V
Coss	Output Capacitance		70		pF	VDS=400V
Crss	Reverse Transfer Capacitance		3.3			f=1.0MHz
Qg	Total Gate Charge		75			VDS=480V
Qgs	Gate- to- Source Charge		14		nC	ID=16.5A
Qgd	Gate-to-Drain(" Miller") Charge		22			VGS=10V

Source- Drain Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current			31	А	Integral pn- diode
ISM	Maximum Pulsed Current			93	А	in MOSFET
VSD	Diode Forward Voltage			1.3	V	IS=16.5A,VGS=0V
trr	Reverse Recovery Time		160		nS	VR=400V
Qrr	Reverse Recovery Charge		7.7		μC	IS=16.5A,di/dt=100 A/μs

Notes:

* 1. Repetitive rating, pulse width limited by maximum junction temperature.

* 2. Pulse Test: Pulse width \leq 300µs, Duty Cycle \leq 2%



Typical Feature Curve

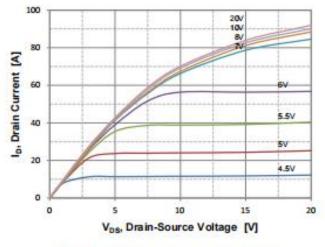


Figure 1. On Region Characteristics

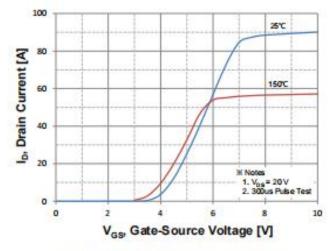
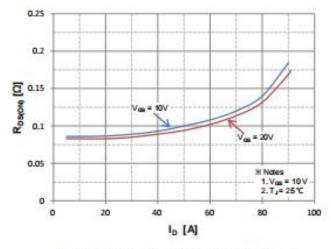
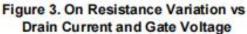


Figure 2. Transfer Characteristics





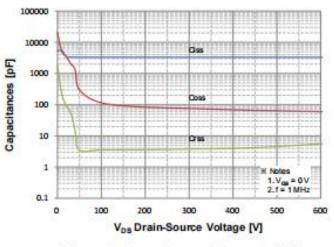


Figure 5. Capacitance Characteristics

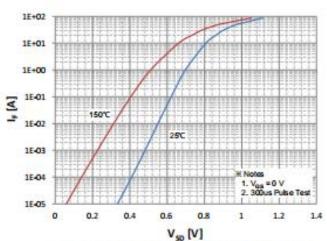


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

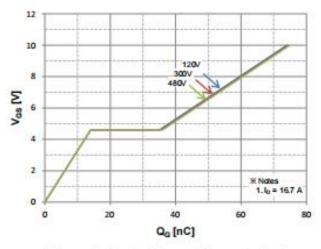
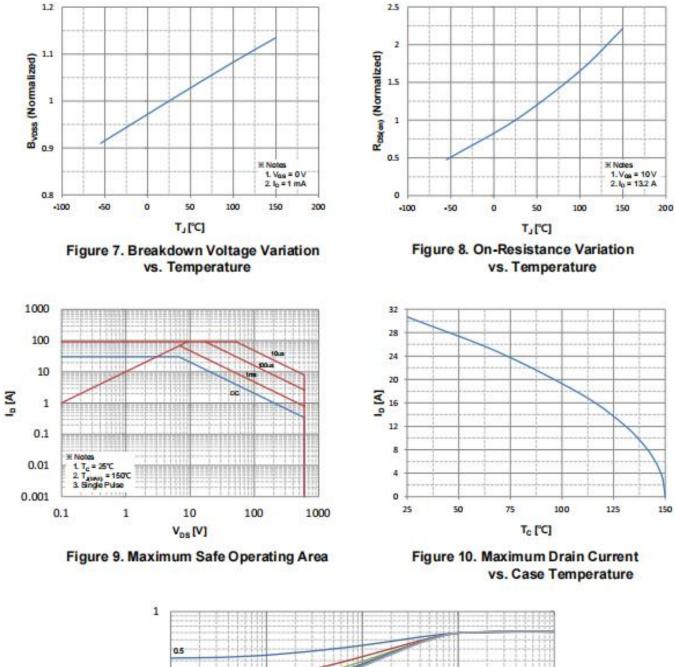


Figure 6. Gate Charge Characteristics





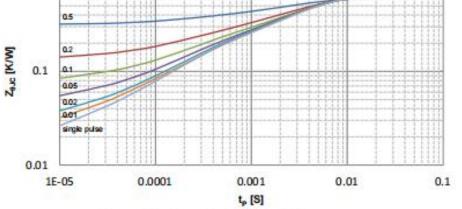
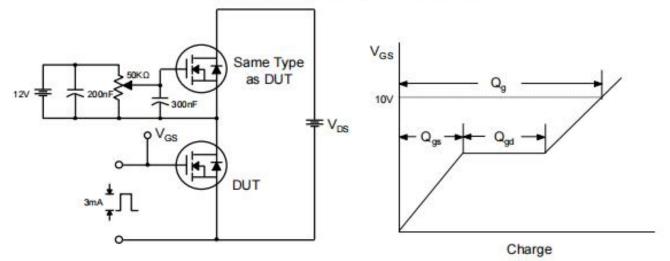


Figure 11. Transient Thermal Response Curve



Test Circuits and Waveforms







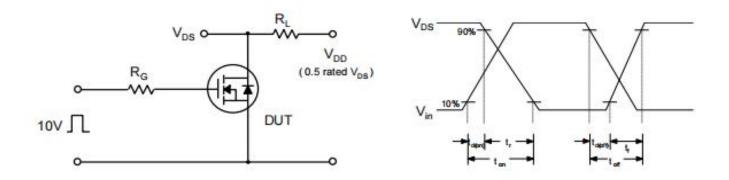
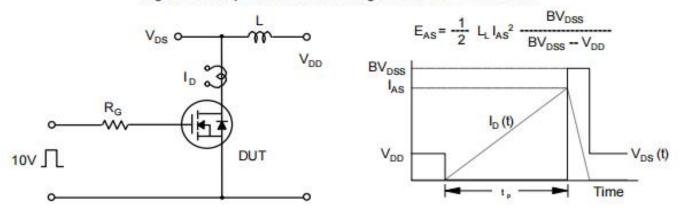


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms





Test Circuits and Waveforms

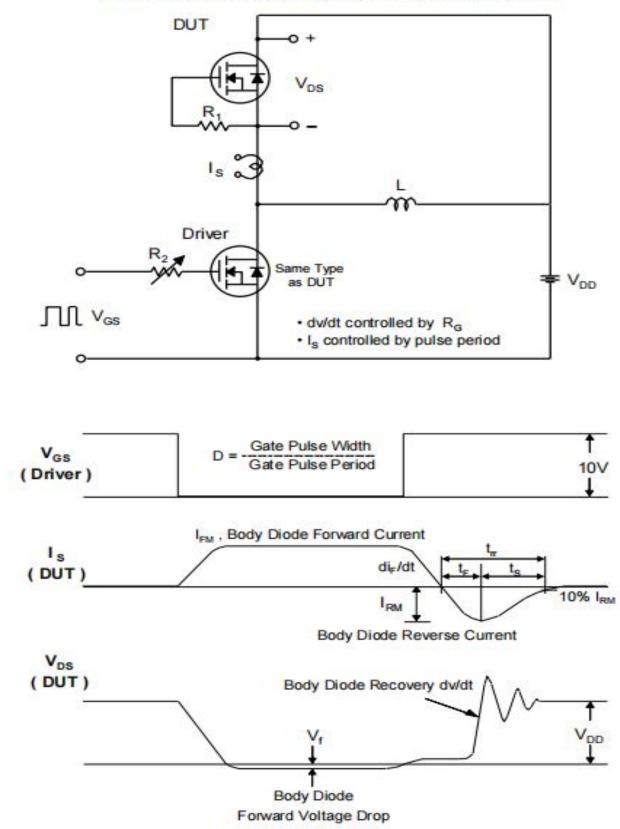
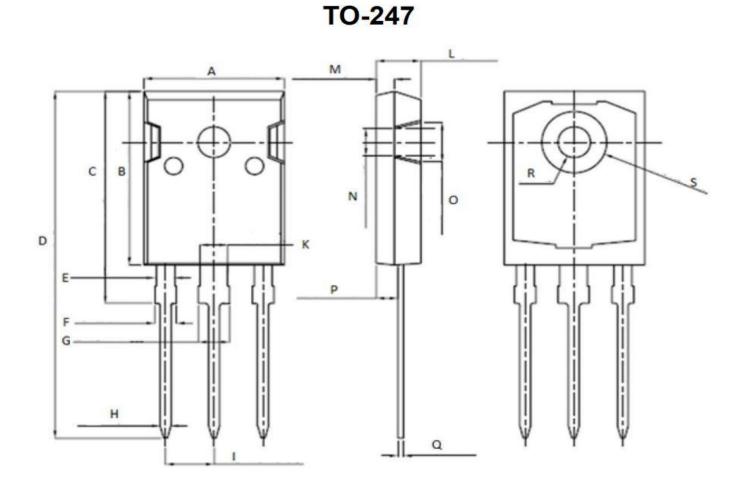


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package outline drawing(TO-247 Unit: mm)



	Unit: mm			Unit: mm	
Symbol	Min.	Max.	Symbol	Min.	Max.
Α	15.95	16.25	K	2.90	3.10
В	20.85	21.25	L	4.90	5.30
C	20.95	21.35	М	1.90	2.10
D	40.5	40.9	N	4.50	4.70
E	1.9	2.1	0	5.40	5.60
F	2.1	2.25	Р	2.29	2.49
G	3.1	3. 25	Q	0.51	0.71
Н	1.1	1.3	R	φ3.5	φ3.7
I.	5.40	5.50	S	φ7.1	φ7.3



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